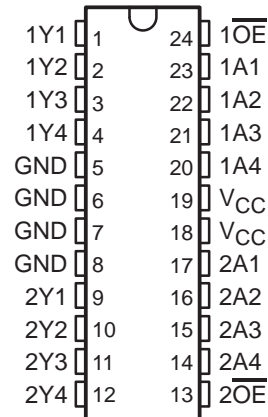


74AC11244 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

SCAS171B – MARCH 1987 – REVISED SEPTEMBER 1998

- **EPIC™ (Enhanced-Performance Implanted CMOS) 1- μ m Process**
- **3-State Outputs Drive Bus Lines or Buffer Memory Address Registers**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise**
- **500-mA Typical Latch-Up Immunity at 125°C**
- **Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, and Standard Plastic DIPs (NT)**

DB, DW, NT, OR PW PACKAGE
(TOP VIEW)



description

The 74AC11244 is an octal buffer or line driver designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The device can be used as two 4-bit buffers or one 8-bit buffer, with active-low output-enable (\overline{OE}) inputs.

When \overline{OE} is low, the device passes noninverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The 74AC11244 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each driver)

INPUTS		OUTPUT
\overline{OE}	A	Y
L	H	H
L	L	L
H	X	Z



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

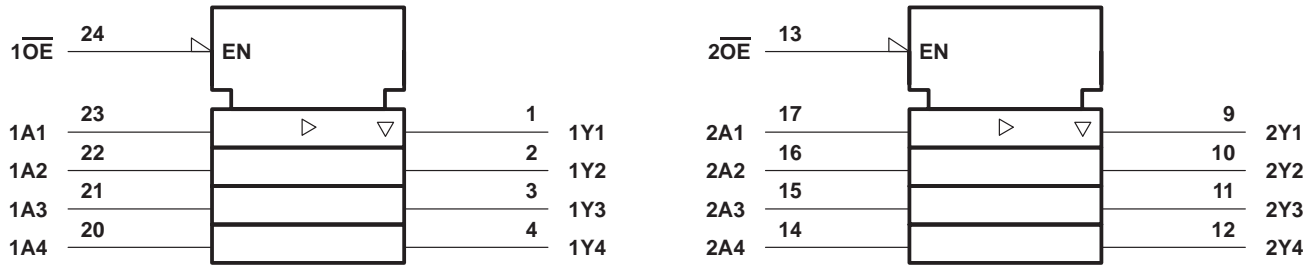
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1998, Texas Instruments Incorporated

74AC11244 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

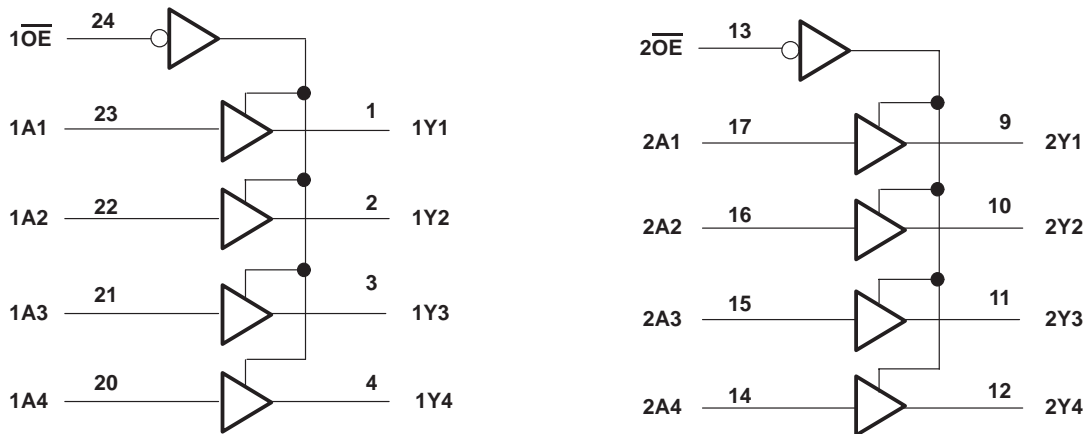
SCAS171B – MARCH 1987 – REVISED SEPTEMBER 1998

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Note 1)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 50 mA
Continuous current through V_{CC} or GND	± 200 mA
Package thermal impedance, θ_{JA} (see Note 2):	
DB package	104°C/W
DW package	81°C/W
PW package	120°C/W
NT package	67°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

74AC11244
OCTAL BUFFER/DRIVER
WITH 3-STATE OUTPUTS

SCAS171B – MARCH 1987 – REVISED SEPTEMBER 1998

recommended operating conditions (see Note 3)

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	3	5	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 3 V	2.1		V
		V _{CC} = 4.5 V	3.15		
		V _{CC} = 5.5 V	3.85		
V _{IL}	Low-level input voltage	V _{CC} = 3 V		0.9	V
		V _{CC} = 4.5 V		1.35	
		V _{CC} = 5.5 V		1.65	
V _I	Input voltage	0		V _{CC}	V
V _O	Output voltage	0		V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 3 V		-4	mA
		V _{CC} = 4.5 V		-24	
		V _{CC} = 5.5 V		-24	
I _{OL}	Low-level output current	V _{CC} = 3 V		12	mA
		V _{CC} = 4.5 V		24	
		V _{CC} = 5.5 V		24	
Δt/Δv	Input transition rise or fall rate	0		10	ns/V
T _A	Operating free-air temperature	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
V _{OH}	I _{OH} = -50 μA	3 V	2.9		2.9		V	
		4.5 V	4.4		4.4			
		5.5 V	5.4		5.4			
	I _{OH} = -4 mA	3 V	2.58		2.48			
		4.5 V	3.94		3.8			
		5.5 V	4.94		4.8			
I _{OH} = -75 mA [†]	5.5 V			3.85				
V _{OL}	I _{OL} = 50 μA	3 V		0.1	0.1		V	
		4.5 V		0.1	0.1			
		5.5 V		0.1	0.1			
	I _{OL} = 12 mA	3 V		0.36	0.44			
		4.5 V		0.36	0.44			
		5.5 V		0.36	0.44			
I _{OL} = 75 mA [†]	5.5 V			1.65				
I _I	V _I = V _{CC} or GND	5.5 V		±0.1	±1	μA		
I _{OZ}	V _O = V _{CC} or GND	5.5 V		±0.5	±5	μA		
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V		8	80	μA		
C _i	V _I = V _{CC} or GND	5 V		4		pF		
C _o	V _O = V _{CC} or GND	5 V		10		pF		

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



74AC11244
OCTAL BUFFER/DRIVER
WITH 3-STATE OUTPUTS

SCAS171B – MARCH 1987 – REVISED SEPTEMBER 1998

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
t_{PLH}	A	Y	1.5	7.1	9.3	1.5	10.2	ns
t_{PHL}			1.5	6.3	8.6	1.5	9.5	
t_{PZH}	\overline{OE}	Y	1.5	8	10.7	1.5	11.8	ns
t_{PZL}			1.5	7.9	10.6	1.5	11.9	
t_{PHZ}	\overline{OE}	Y	1.5	5.9	7.9	1.5	8.3	ns
t_{PLZ}			1.5	7.2	9.4	1.5	9.9	

switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

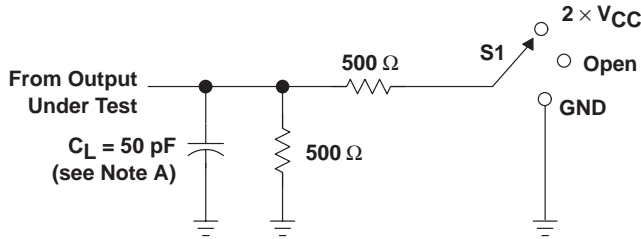
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
t_{PLH}	A	Y	1.5	4.9	6.7	1.5	7.3	ns
t_{PHL}			1.5	4.5	6.4	1.5	6.9	
t_{PZH}	\overline{OE}	Y	1.5	5.4	7.7	1.5	8.5	ns
t_{PZL}			1.5	5.4	7.6	1.5	8.5	
t_{PHZ}	\overline{OE}	Y	1.5	5.2	7	1.5	7.3	ns
t_{PLZ}			1.5	5.8	7.8	1.5	8.2	

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance per buffer/driver	Outputs enabled	27	pF
		Outputs disabled	9	

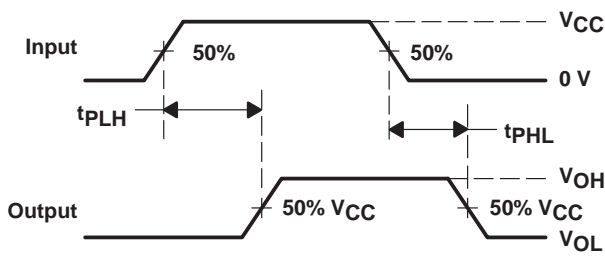


PARAMETER MEASUREMENT INFORMATION

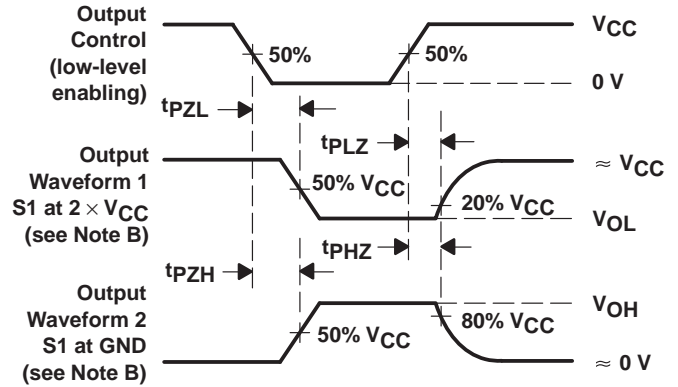


TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND

LOAD CIRCUIT



VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AC11244DBLE	OBSOLETE	SSOP	DB	24		None	Call TI	Call TI
74AC11244DBR	ACTIVE	SSOP	DB	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
74AC11244DW	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
74AC11244DWR	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
74AC11244NSR	ACTIVE	SO	NS	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
74AC11244NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
74AC11244PW	ACTIVE	TSSOP	PW	24	60	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
74AC11244PWLE	OBSOLETE	TSSOP	PW	24		None	Call TI	Call TI
74AC11244PWR	ACTIVE	TSSOP	PW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

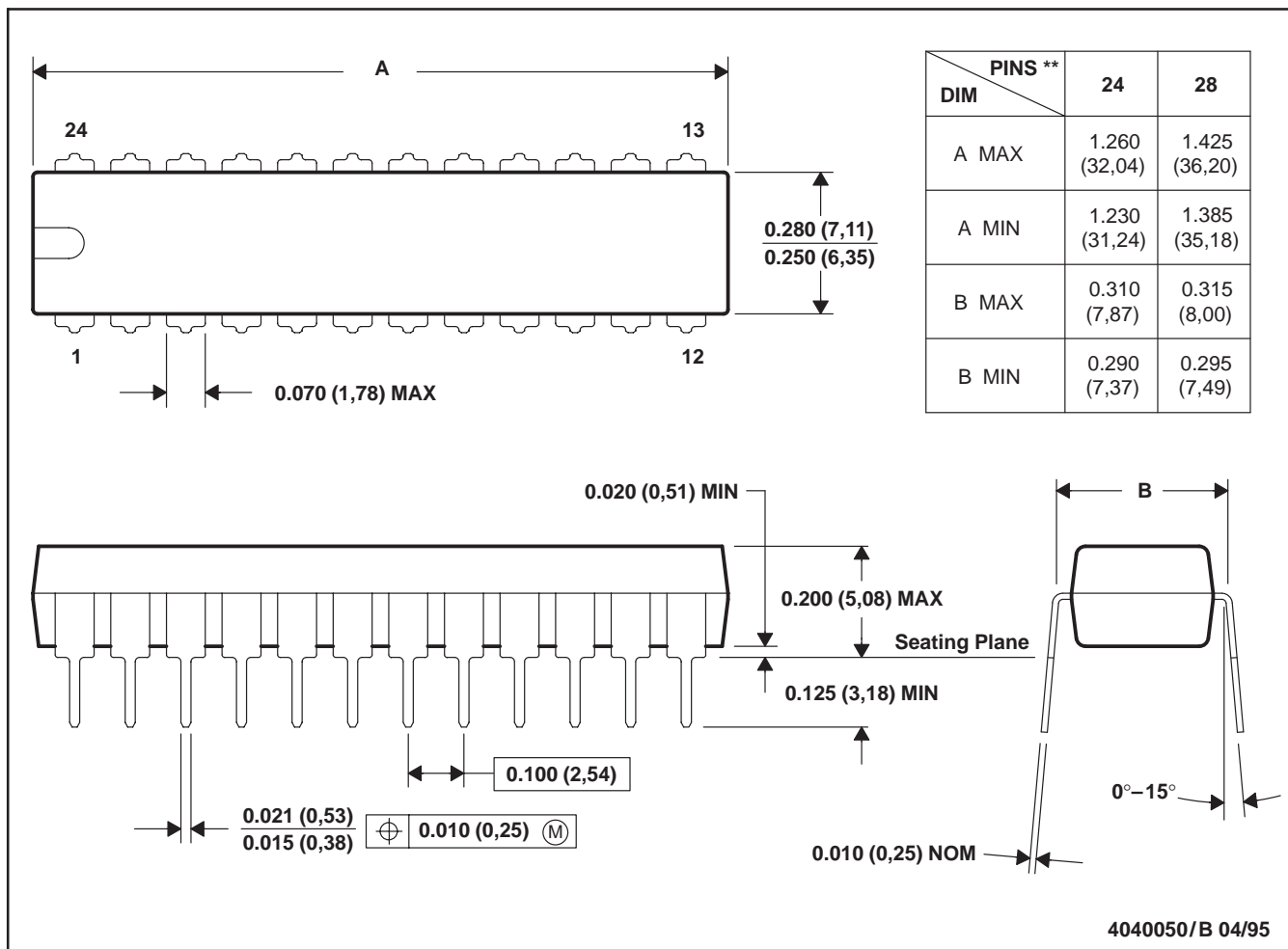
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

NT (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



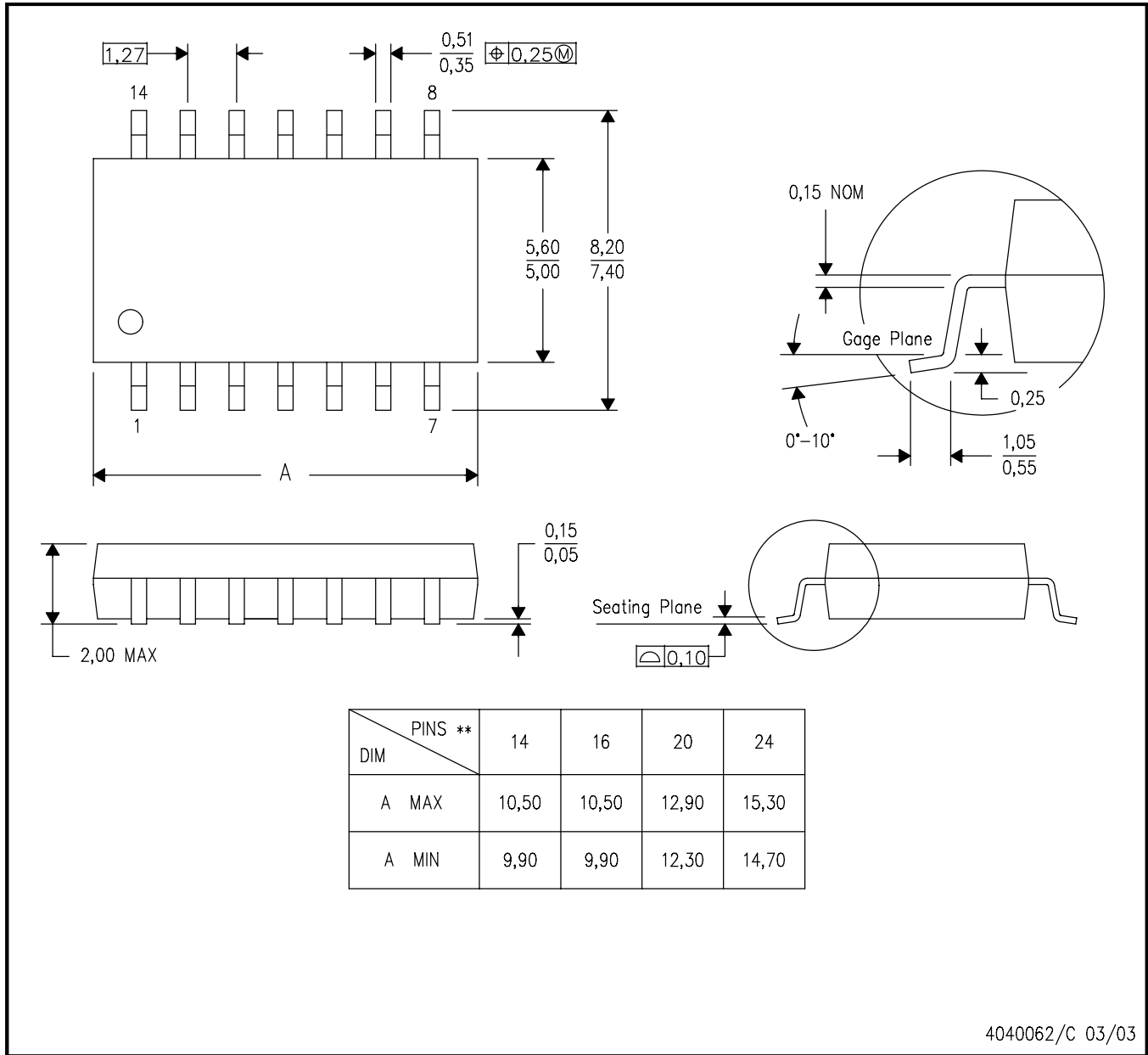
NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

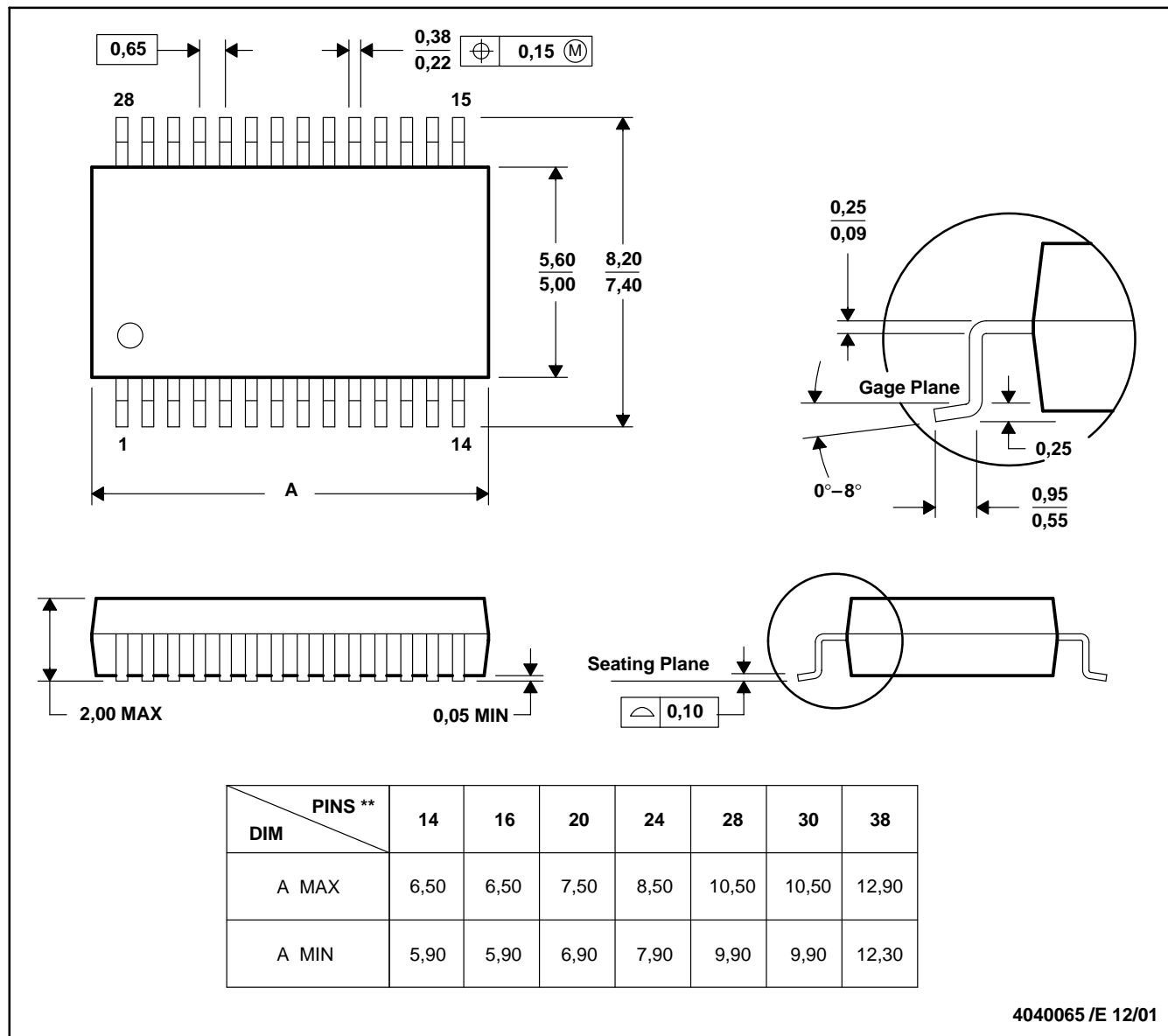


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

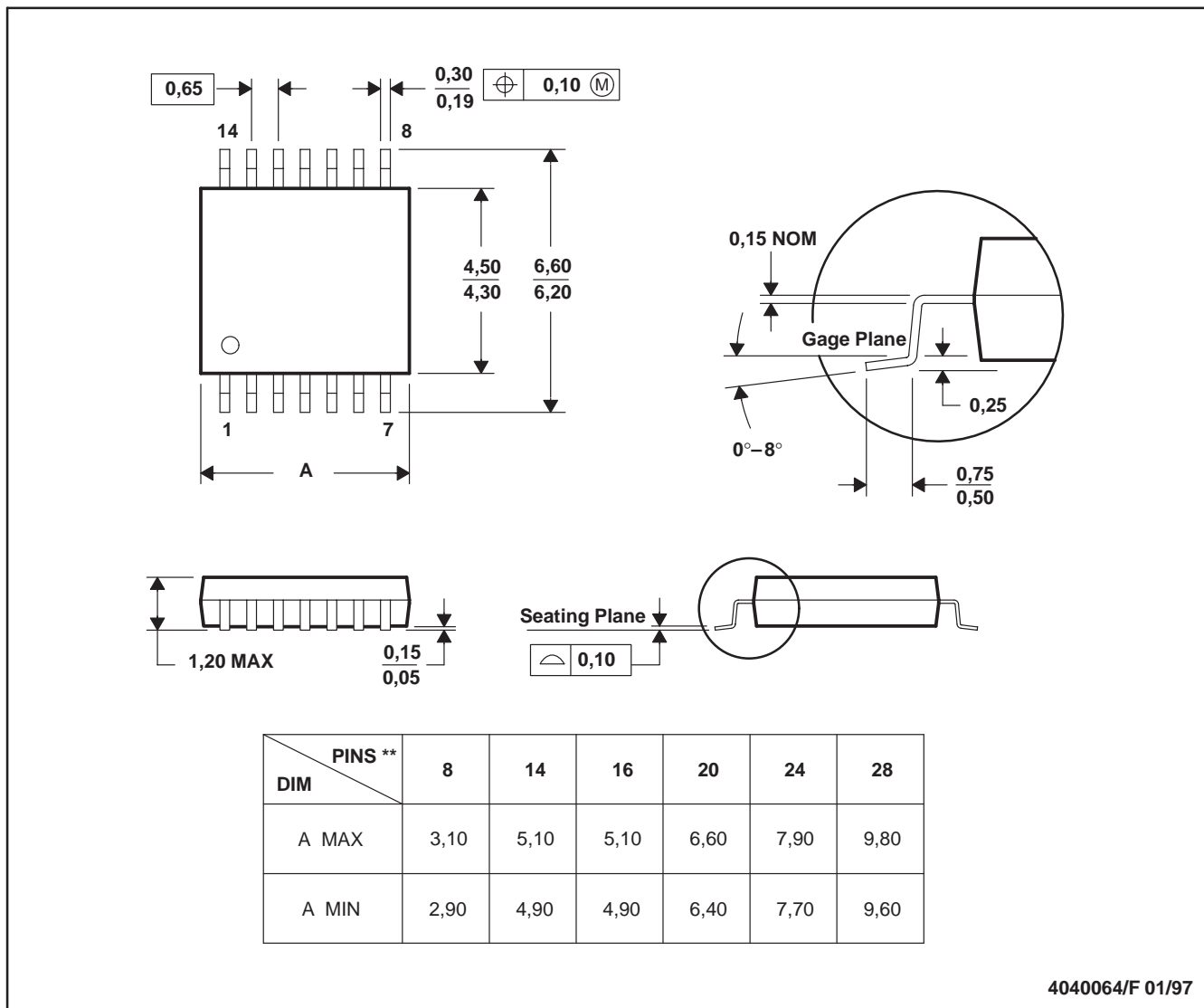


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

Texas Instruments

<http://www.ti.com>

This file is the datasheet for the following electronic components:

74AC11244 - <http://www.ti.com/product/74ac11244?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244DWR - <http://www.ti.com/product/74ac11244dwr?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244PW - <http://www.ti.com/product/74ac11244pw?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244NSR - <http://www.ti.com/product/74ac11244nsr?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244NT - <http://www.ti.com/product/74ac11244nt?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244PWLE - <http://www.ti.com/product/74ac11244pwle?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244PWR - <http://www.ti.com/product/74ac11244pwr?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244DBLE - <http://www.ti.com/product/74ac11244dbble?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244DW - <http://www.ti.com/product/74ac11244dw?HQS=TI-null-null-dscatalog-df-pf-null-ww>

74AC11244DBR - <http://www.ti.com/product/74ac11244dbr?HQS=TI-null-null-dscatalog-df-pf-null-ww>



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

LittleDiode.com

Looking forward to providing you with the best possible service.